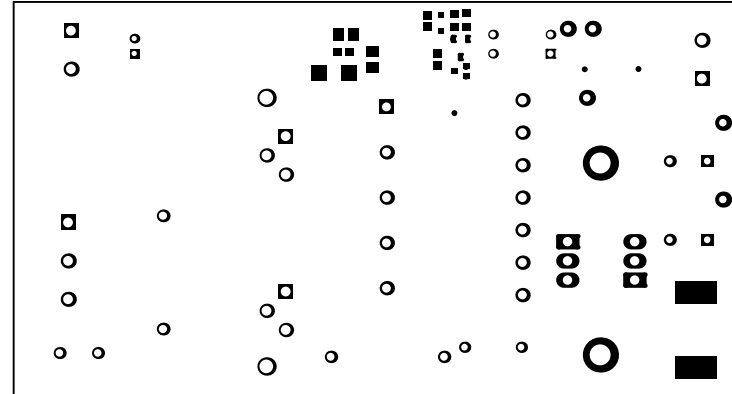
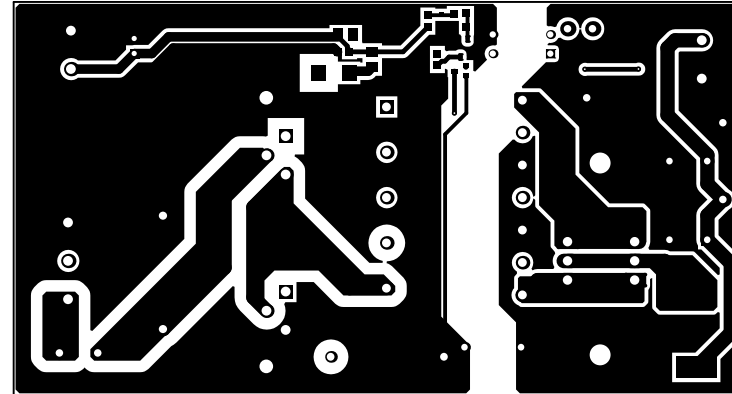


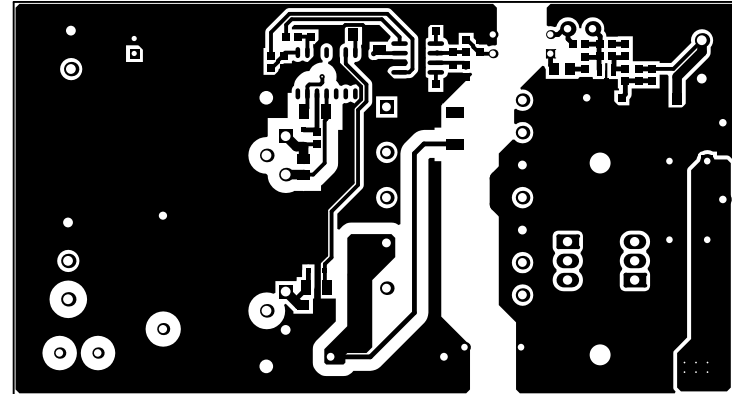
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 10/8/2015 12:49:21 PM	TEXAS INSTRUMENTS	



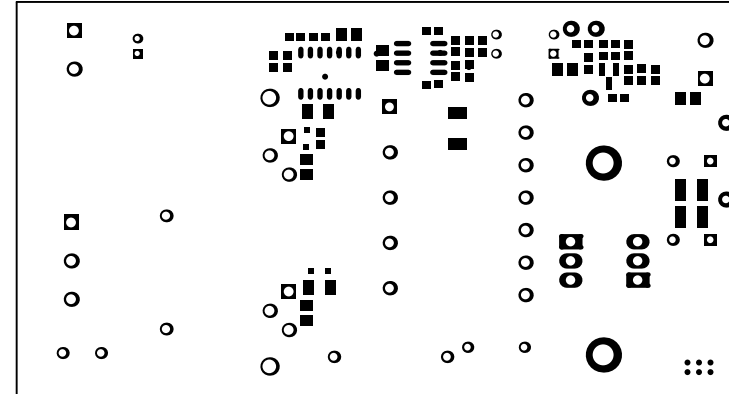
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 10/8/2015 12:49:22 PM	TEXAS INSTRUMENTS	



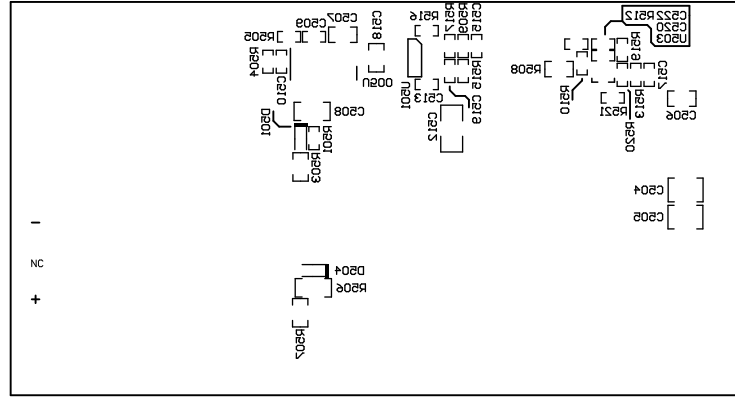
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 10/8/2015 12:49:23 PM	TEXAS INSTRUMENTS	



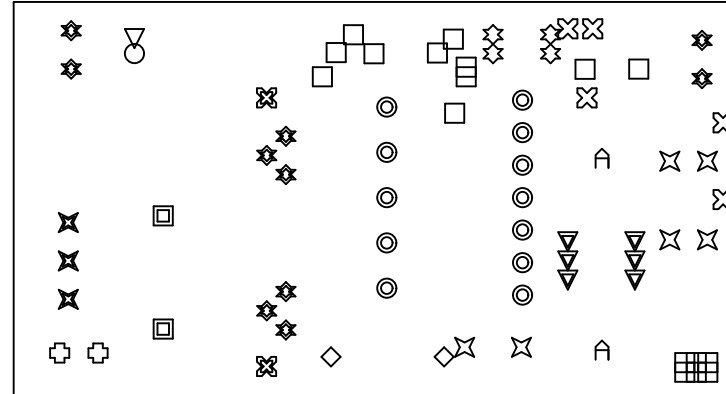
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 10/8/2015 12:49:24 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/8/2015 12:49:24 PM	TEXAS INSTRUMENTS	

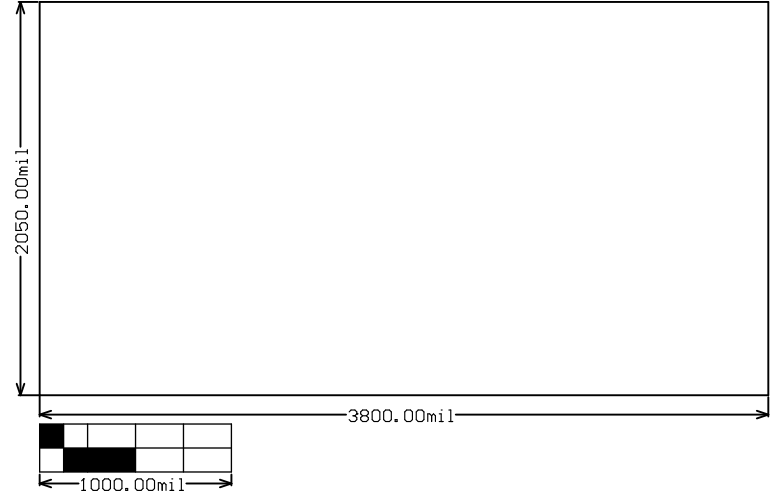


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 10/8/2015 12:49:25 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
□	17	10.00mil (0.254mm)	PTH	Round
○	1	28.00mil (0.711mm)	PTH	Round
▽	1	28.01mil (0.712mm)	PTH	Round
☆	4	33.46mil (0.850mm)	PTH	Round
✕	6	35.43mil (0.900mm)	PTH	Round
⊗	2	39.37mil (1.000mm)	PTH	Round
⊗	5	40.00mil (1.016mm)	PTH	Round
◇	2	41.34mil (1.050mm)	PTH	Round
■	2	43.31mil (1.100mm)	PTH	Round
●	12	47.24mil (1.200mm)	PTH	Round
▽	6	50.00mil (1.270mm)	PTH	Round
☆	10	51.18mil (1.300mm)	PTH	Round
✕	3	52.00mil (1.321mm)	PTH	Round
⊗	2	72.83mil (1.850mm)	PTH	Round
⌢	2	110.24mil (2.800mm)	PTH	Round
	75 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 10/8/2015	12:49:26 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP9750	REV: B	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 10/8/2015 12:49:27 PM	TEXAS INSTRUMENTS	

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